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Part Number: 0740401343

Status: Active

Overview: VHDM Backplane Connector Systems

Description: VHDM Daughtercard, 2.00mm Pitch, 8-Rows, 25 Wafers, 200 Circuits, Tin Lead, Guide

Module

Documents:

<u>Drawing (PDF)</u> <u>Packaging Specification PK-70873-5041-001 (PDF)</u>

Product Specification PS-74031-999-001 (PDF) RoHS Certificate of Compliance (PDF)

Agency Certification

UL E29179

General

Product Family Backplane Connectors

Series 74040
Application Backplane

Application Tooling Documents

Comments

Daughter Card

Component Type

PCB Header

Overview <u>VHDM Backplane Connector Systems</u>

Product Name VHDM

UPC 883906551841

Physical

Circuits (Loaded) 200 Circuits (maximum) 200 Color - Resin Black Durability (mating cycles max) 200 First Mate / Last Break No Flammability 94V-0 **Guide to Mating Part** Yes Keying to Mating Part N/A

Material - Metal Copper Alloy
Material - Plating Mating Gold
Material - Plating Termination Matte Tin

Material - Resin High Performance Thermoplastic

Net Weight59.065/gNumber of Columns25Number of PairsN/ANumber of Rows8OrientationRight Angle

PC Tail Length 2.80mm PCB Locator No **PCB** Retention None PCB Thickness - Recommended 1.80mm Packaging Type Tube Pitch - Mating Interface 2.00mm Plating min - Mating 0.762µm Polarized to PCB No Stackable Yes

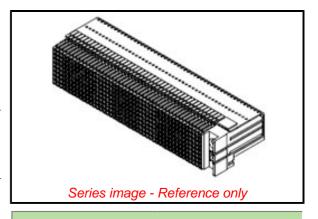
Temperature Range - Operating -55° to +80°C

Termination Interface: Style Through Hole - Compliant Pin

Electrical

Surface Mount Compatible (SMC)

Current - Maximum per Contact 1.0A



EU ELV

Not Relevant

EU RoHS China RoHS

Compliant REACH SVHC Not Contained Per -D(2021)4569-DC (8 July 2021)

Halogen-Free

Status

Low-Halogen

For more information, please visit Contact US

China ROHS Green Image
ELV Not Relevant
RoHS Phthalates Not Contained

Search Parts in this Series

74040 Series

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

DescriptionProduct #Card Stiffener622016200

Removal Tool

Data Rate 3.125 Gbps

Shielded Yes

Voltage - Maximum 120V AC (RMS)/DC

Solder Process Data

Lead-freeProcess Capability N/A

Material Info

Reference - Drawing Numbers

Packaging Specification PK-70873-5041-001
Product Specification PS-74031-999-001

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